

# Description

The HXY4805S uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gat e charge. It can be used in a wide variety of applications.

# **General Features**

VDS = -30V,ID = -8.5A

 $R_{DS(ON)} < 25m @ V_{GS}=-10V$ 

 $R_{DS(ON)} < 42m @ V_{GS} = -4.5V$ 

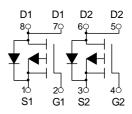
# Application

PWM application

Load switch



SOP-8



#### **Dual P-Channel MOSFET**

#### Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HXY4805S	SOP-8	4805 XXXX	3000

# Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Symbol	Parameter	Limit	Unit	
Vds	Drain-Source Voltage	-30	V	
Vgs	Gate-Source Voltage	±20	V	
l <sub>D</sub>	Drain Current-Continuous	-8.5	A	
Ырм	Drain Current-Pulsed (Note 1)	-26	А	
PD	Maximum Power Dissipation	1.5	W	
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C	
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	85	°C/W	



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-30			V
$\triangle BV_{DSS} / \triangle T_J$	BV <sub>DSS</sub> Temperature Coefficient	Reference to $25^{\circ}$ C , I <sub>D</sub> =-1mA		-0.022		V/°C
P	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-6A		20	25	
Rds(ON)		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-4A		25	42	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	VGS=VDS . ID =-250uA	-1.0		-2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=-2300A$		4.6		mV/°C
	Dursin Source Lookene Current	V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			-1	
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			-5	uA
lgss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-6A		17		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		13		Ω
Qg	Total Gate Charge (-4.5V)			12.6		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-6A		4.8		nC
$Q_gd$	Gate-Drain Charge			4.8		
T <sub>d(on)</sub>	Turn-On Delay Time			4.6		
Tr	Rise Time	$V_{DD}$ =-15V , $V_{GS}$ =-10V , $R_G$ =3.3 $\Omega$ ,		14.8		
T <sub>d(off)</sub>	Turn-Off Delay Time	ID=-6A		41		ns
T <sub>f</sub>	Fall Time			19.6		
Ciss	Input Capacitance			1345		
Coss	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		194		pF
Crss	Reverse Transfer Capacitance			158		

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,5</sup>	V- V- OV Force Current			-6.5	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,5</sup>	$V_G=V_D=0V$ , Force Current			-26	А
Vsd	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time			16.3		nS
Qrr	Reverse Recovery Charge	I⊧=-6A , dI/dt=100A/µs , Tյ=25°C		5.9		nC

Note :

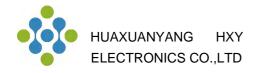
1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

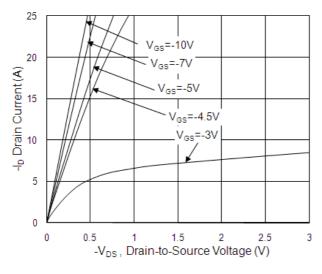
3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =-25V,  $V_{GS}$ =-10V, L=0.1mH, I<sub>AS</sub>=-38A

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



### **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

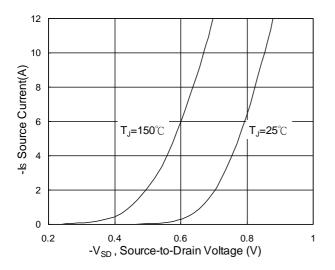


Fig.3 Forward Characteristics of Reverse

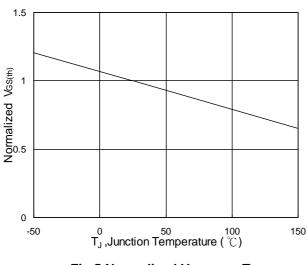


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

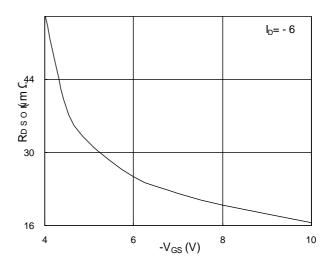
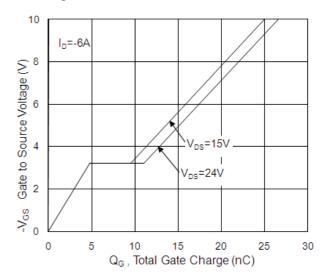


Fig.2 On-Resistance v.s Gate-Source



**Fig.4 Gate-Charge Characteristics** 

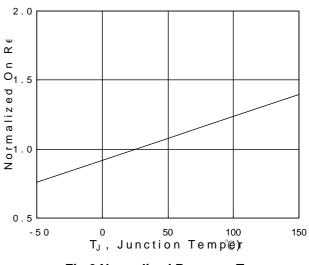
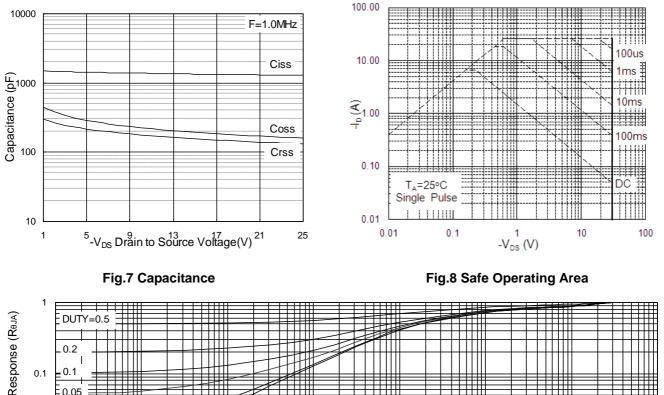


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



# HXY4805S Dual P-Channel Enhancement Mode MOSFET



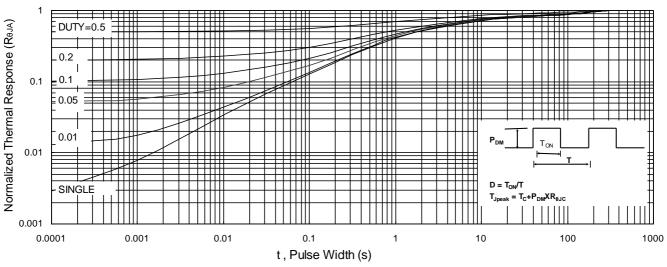


Fig.9 Normalized Maximum Transient Thermal Impedance

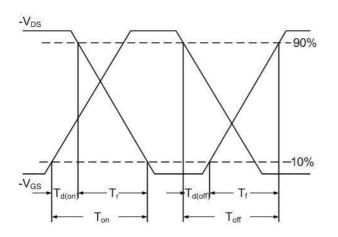
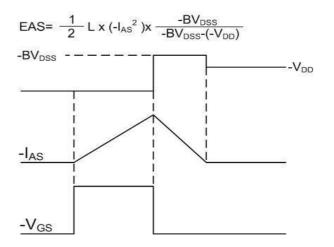
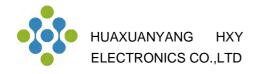


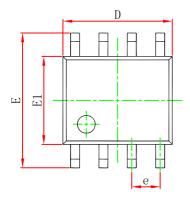
Fig.10 Switching Time Waveform

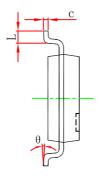


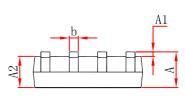
#### Fig.11 Unclamped Inductive Switching Waveform



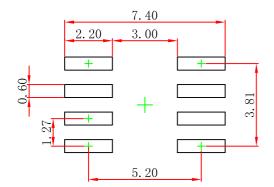
# **SOP-8 Package Outline Dimensions**







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



Note: 1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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